

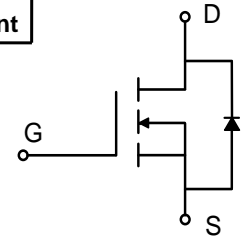
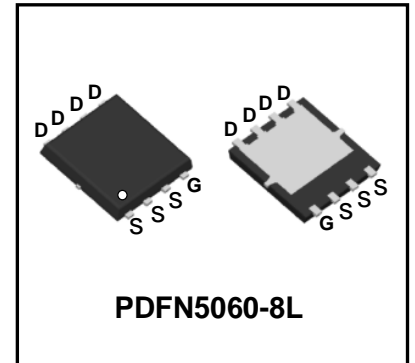
## 120V N-Channel Enhancement Mode Power MOSFET

### Description

WMB125N12LG2 uses Wayon's 2<sup>nd</sup> generation POWER TRENCH MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.

### Features

- $V_{DS} = 120V$ ,  $I_D = 61A$ (Silicon Limited)  
 $R_{DS(on)} < 12.5m\Omega @ V_{GS} = 10V$   
 $R_{DS(on)} < 17m\Omega @ V_{GS} = 4.5V$
- Green Device Available
- 100% EAS Guaranteed
- Optimized for High Speed Smooth Switching



### Applications

- Power Management Switches
- DC/DC Converters
- Synchronous Rectification in SMPS

### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source voltage	$V_{DS}$	120	V
Gate-Source voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup> (Silicon Limited)	$I_D$	$T_C=25^\circ C$	61
		$T_C=100^\circ C$	38
Continuous Drain Current <sup>1</sup> (Package Limited)		$T_C=25^\circ C$	60
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	250	A
Single Pulse Avalanche Energy <sup>3</sup>	<b>EAS</b>	245	mJ
Avalanche Current	$I_{AS}$	35	A
Total Power Dissipation <sup>4</sup>	$P_D$	92	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ C$

### Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient <sup>1</sup>	$R_{\theta JA}$	49.6	$^\circ C/W$
Thermal Resistance from Junction-to-Case <sup>1</sup>	$R_{\theta JC}$	1.3	$^\circ C/W$

**Electrical Characteristics**  $T_c = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	120	-	-	V
Gate-body Leakage Current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	$\pm 100$	nA
Zero Gate Voltage Drain Current	$T_J=25^\circ\text{C}$	$V_{DS} = 120V, V_{GS} = 0V$	-	-	1	$\mu A$
	$T_J=100^\circ\text{C}$		-	-	100	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.2	2.0	2.5	V
Drain-Source On-Resistance <sup>2</sup>	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$	-	9.7	12.5	m $\Omega$
		$V_{GS} = 4.5V, I_D = 20A$	-	12	17	
Forward Transconductance	$g_{fs}$	$V_{DS} = 5V, I_D = 20A$	-	64	-	S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 60V, V_{GS} = 0V, f = 1\text{MHz}$	-	2100	-	pF
Output Capacitance	$C_{oss}$		-	245	-	
Reverse Transfer Capacitance	$C_{rss}$		-	10	-	
<b>Switching Characteristics</b>						
Gate Resistance	$R_g$	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	-	2.1	-	$\Omega$
Total Gate Charge	$Q_g$	$V_{GS} = 4.5V, V_{DD} = 60V, I_D = 20A$	-	14.7	-	nC
Total Gate Charge	$Q_g$	$V_{GS} = 10V, V_{DD} = 60V, I_D = 20A$	-	30.5	-	
Gate-Source Charge	$Q_{gs}$		-	7.9	-	
Gate-Drain Charge	$Q_{gd}$		-	4.0	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 60V, R_G = 10\Omega, I_D = 20A$	-	10.5	-	nS
Rise Time	$t_r$		-	8.8	-	
Turn-Off Delay Time	$t_{d(off)}$		-	17	-	
Fall Time	$t_f$		-	9.8	-	
<b>Drain-Source Body Diode Characteristics</b>						
Diode Forward Voltage <sup>2</sup>	$V_{SD}$	$I_S = 1A, V_{GS} = 0V$	-	-	1.2	V
Reverse Recovery Time	$t_{rr}$	$V_R = 60V, I_F = 20A, di_F/dt = 100A/\mu s$	-	49	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	73	-	nC

## Notes:

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is  $V_{DD}=25V, V_{GS}=10V, L=0.4mH, I_{AS}=35A$
4. The power dissipation is limited by  $150^\circ\text{C}$  junction temperature

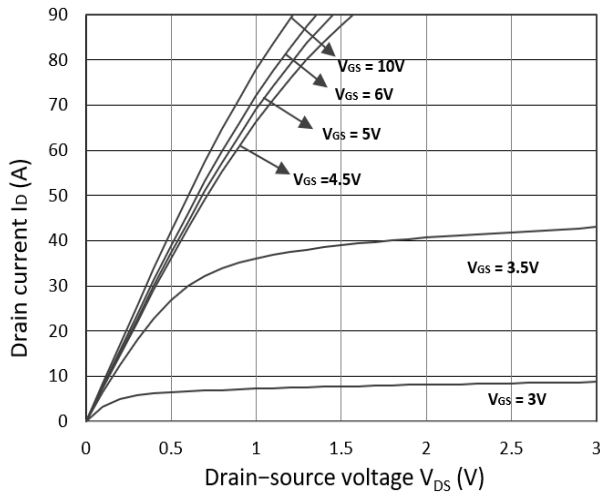


Figure 1. Output Characteristics

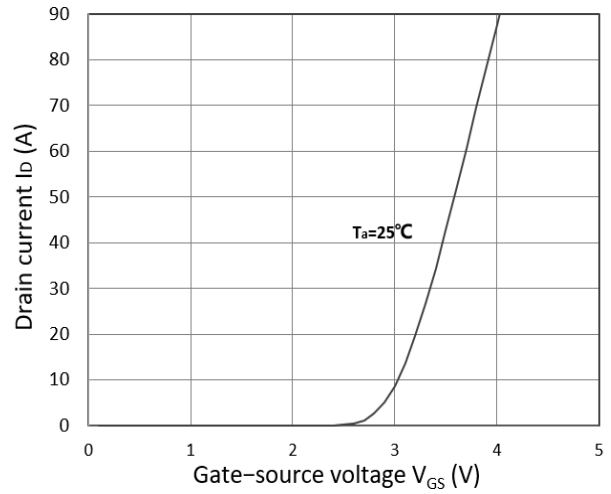


Figure 2. Transfer Characteristics

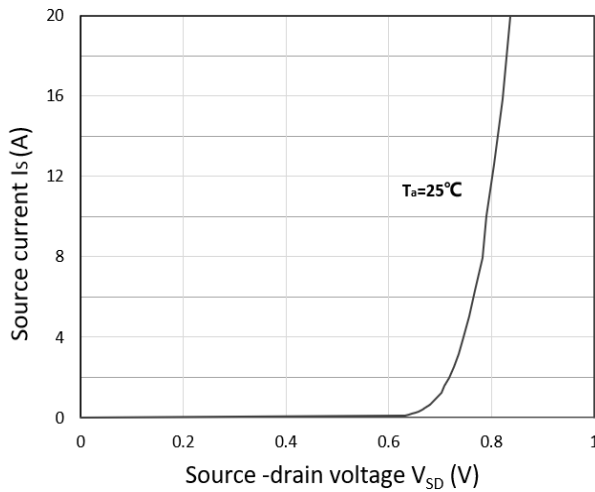


Figure 3. Forward Characteristics of Reverse

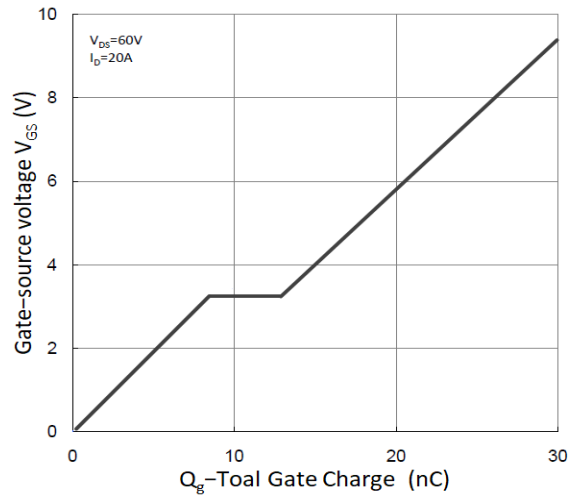


Figure 4. Gate Charge Characteristics

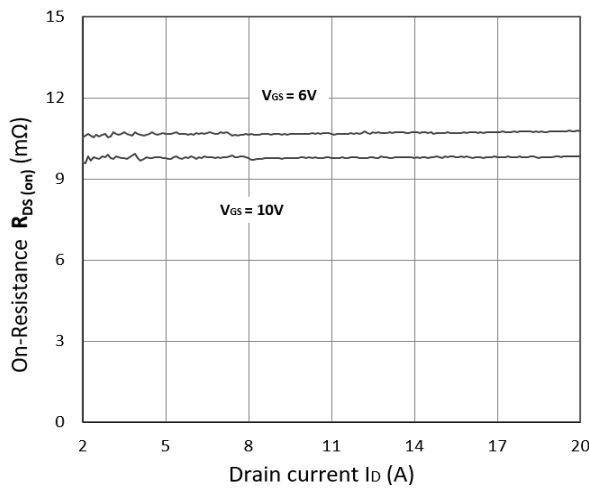


Figure 5.  $R_{DS(ON)}$  Vs  $I_D$

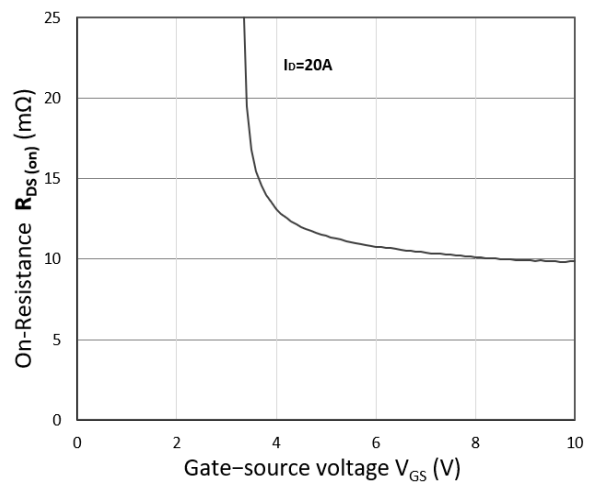


Figure 6.  $R_{DS(ON)}$  vs.  $V_{GS}$

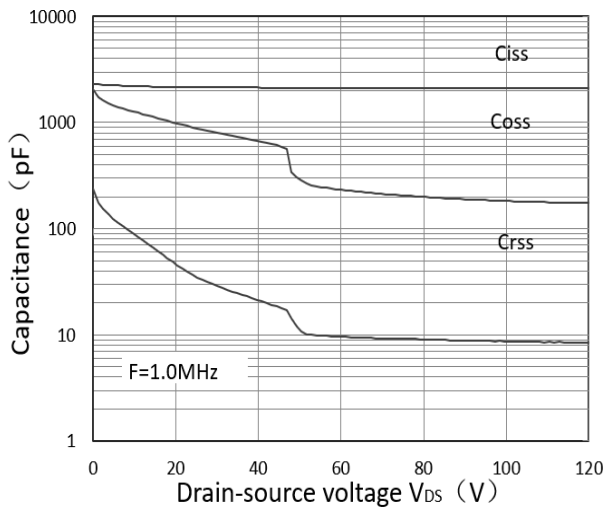


Figure 7. Capacitance Characteristics

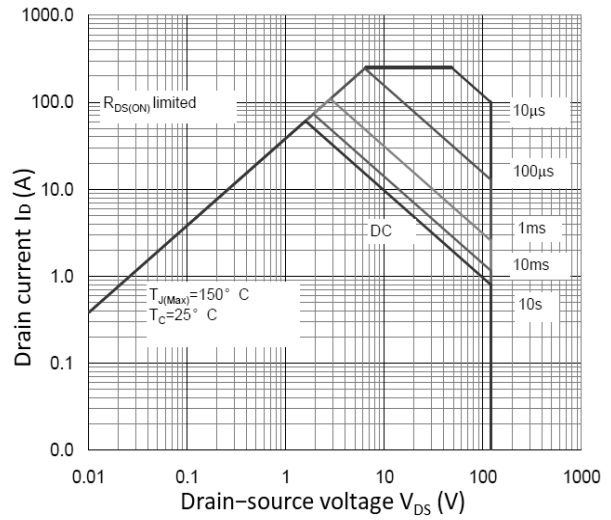


Figure 8. Safe Operating Area

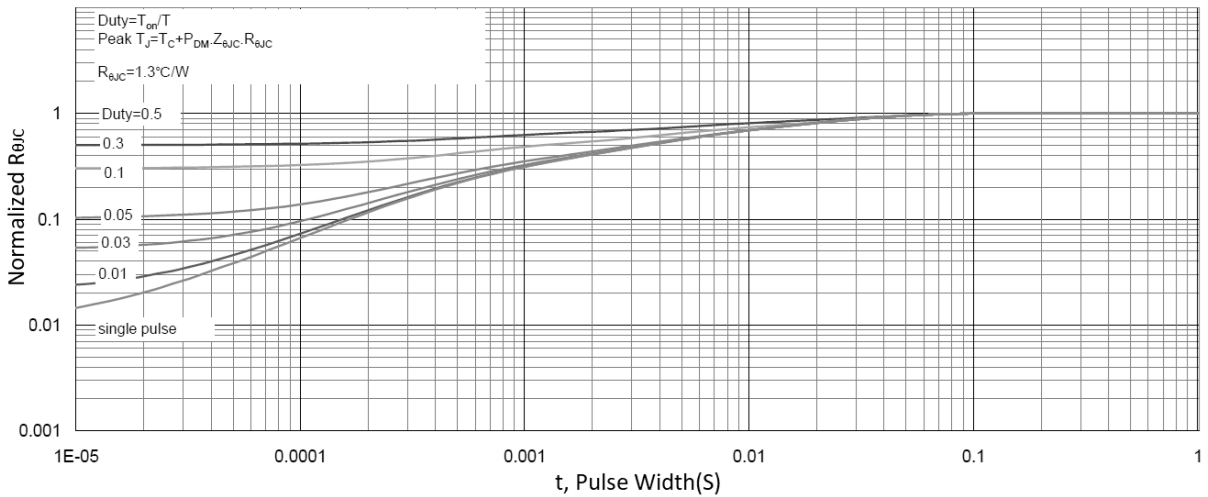


Figure 9. Normalized Maximum Transient Thermal Impedance

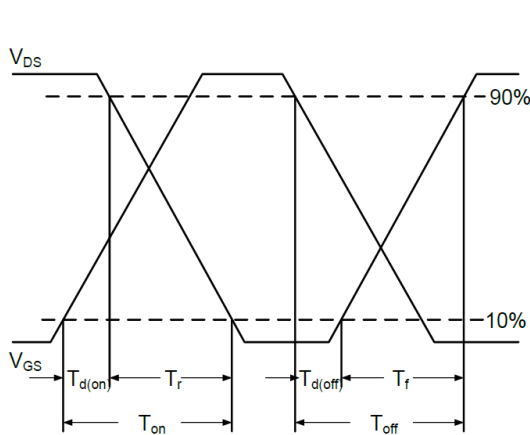


Figure 9. Switching Time Waveform

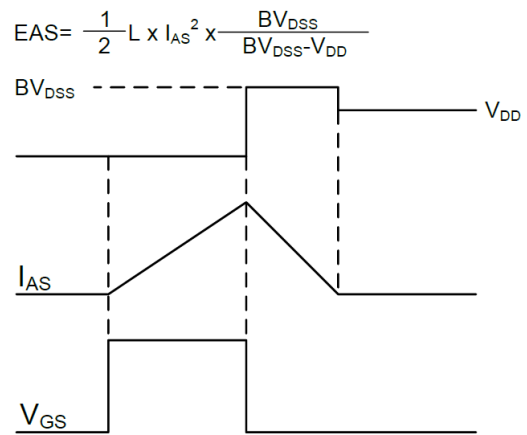
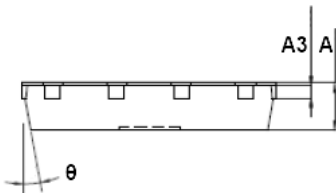
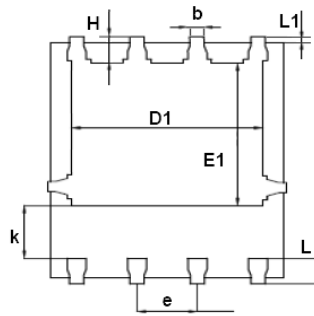
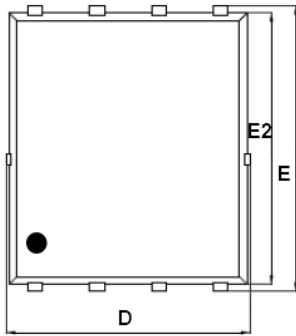


Figure 10. Unclamped Inductive Switching Waveform

## Mechanical Dimensions for PDFN5060-8L

## COMMON DIMENSIONS

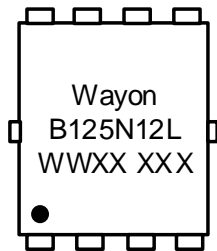


SYMBOL	MM	
	MIN	MAX
A	0.90	1.17
A3	0.20	0.35
D	4.80	5.40
E	5.90	6.15
D1	3.61	4.31
E1	3.30	3.78
E2	5.65	5.85
k	1.10	-
b	0.30	0.51
e	1.27BSC	
L	0.38	0.71
L1	0.05	0.36
H	0.38	0.61
$\theta$	0°	12°

## Ordering Information

Part	Package	Marking	Packing method
WMB125N12LG2	PDFN5060-8L	B125N12L	Tape and Reel

## Marking Information



B125N12L = Device code

WWXX XXX= Date code

## Contact Information

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